

**KU LEUVEN**



University of Colorado  
Boulder

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# 3D Simulation of electron scale turbulent currents in reconnection outflows

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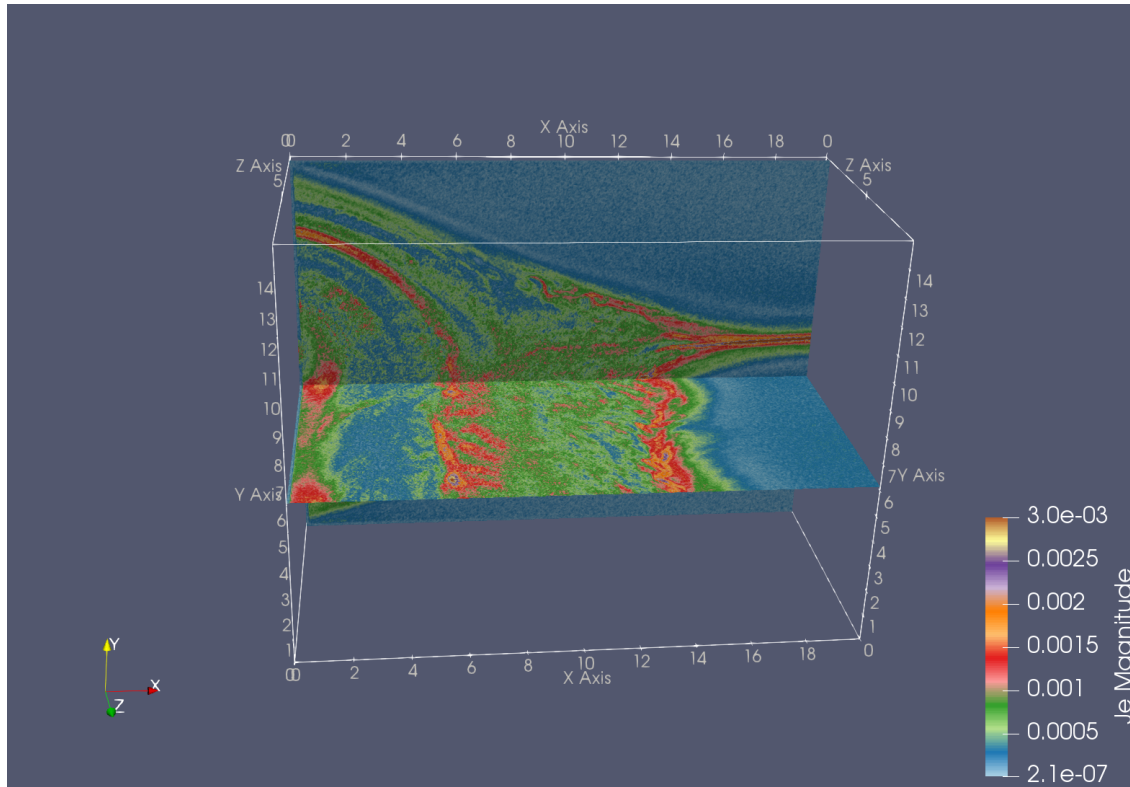


Acknowledgments

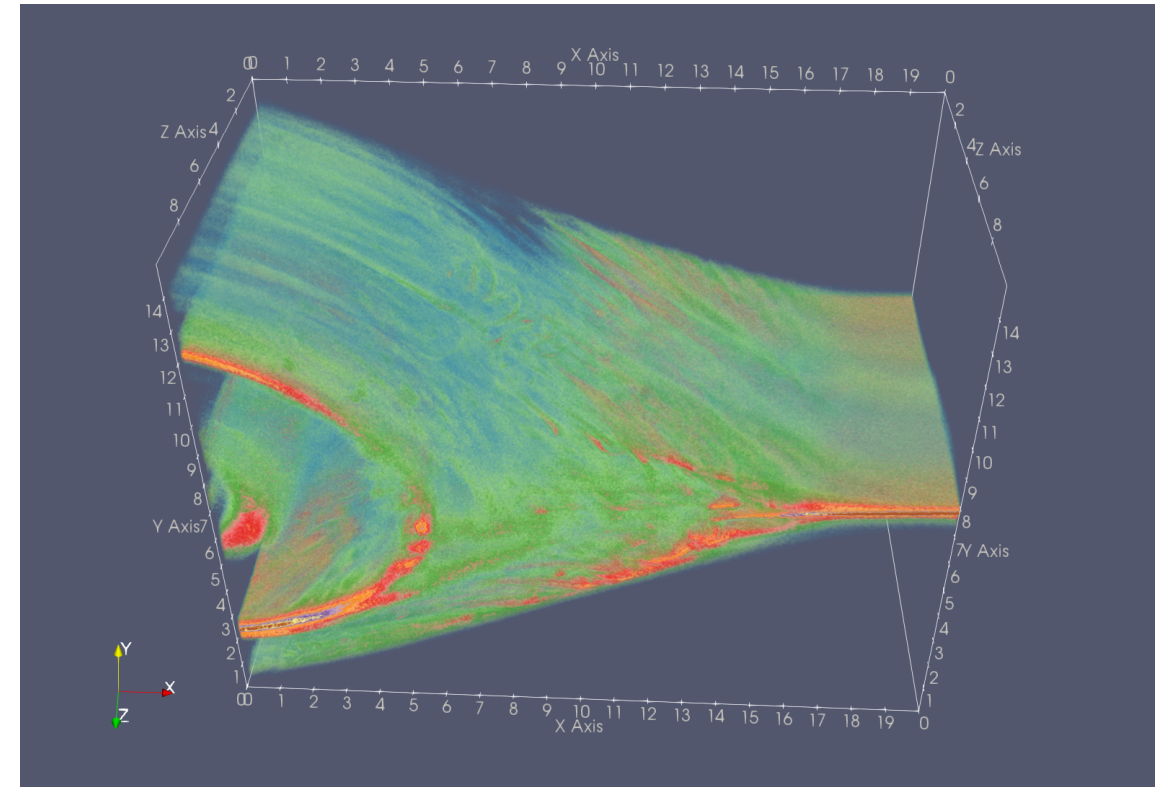


# 3D reconnection leads to very non laminar outflows

Mi/me=256  
B<sub>g</sub>=1/10  
Grid:1200x450x300  
Resolution  $\Delta x = d_e/2$   
Resolution  $\omega_{ce} \Delta t = 1/30$



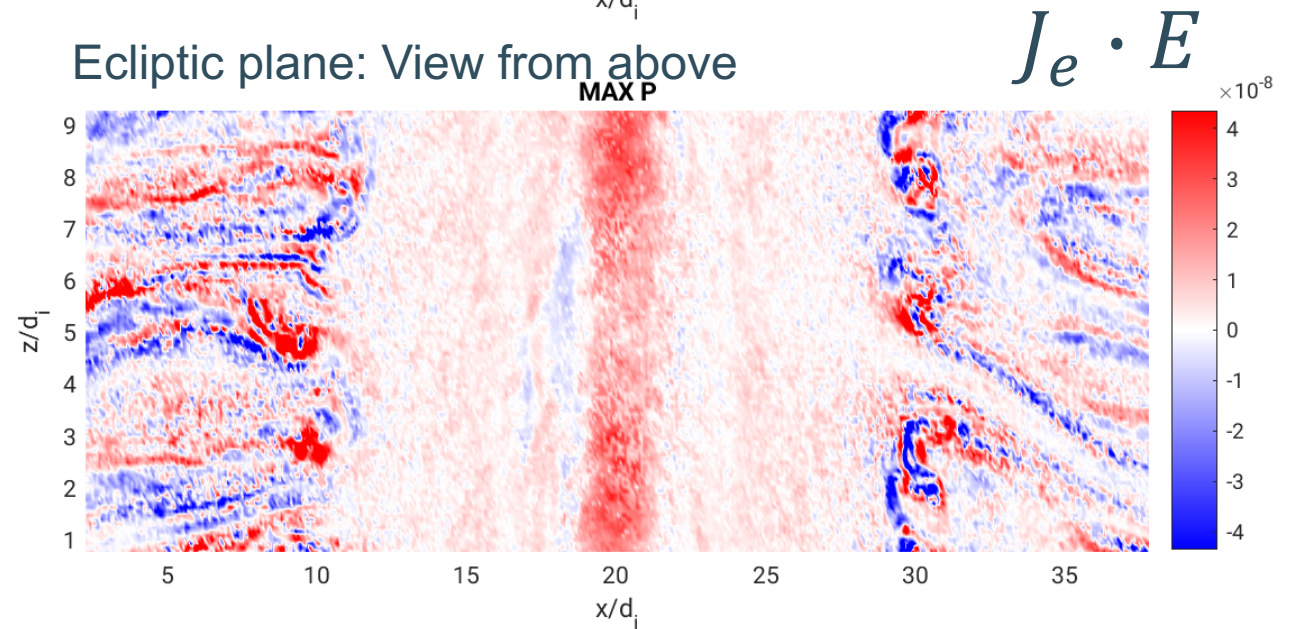
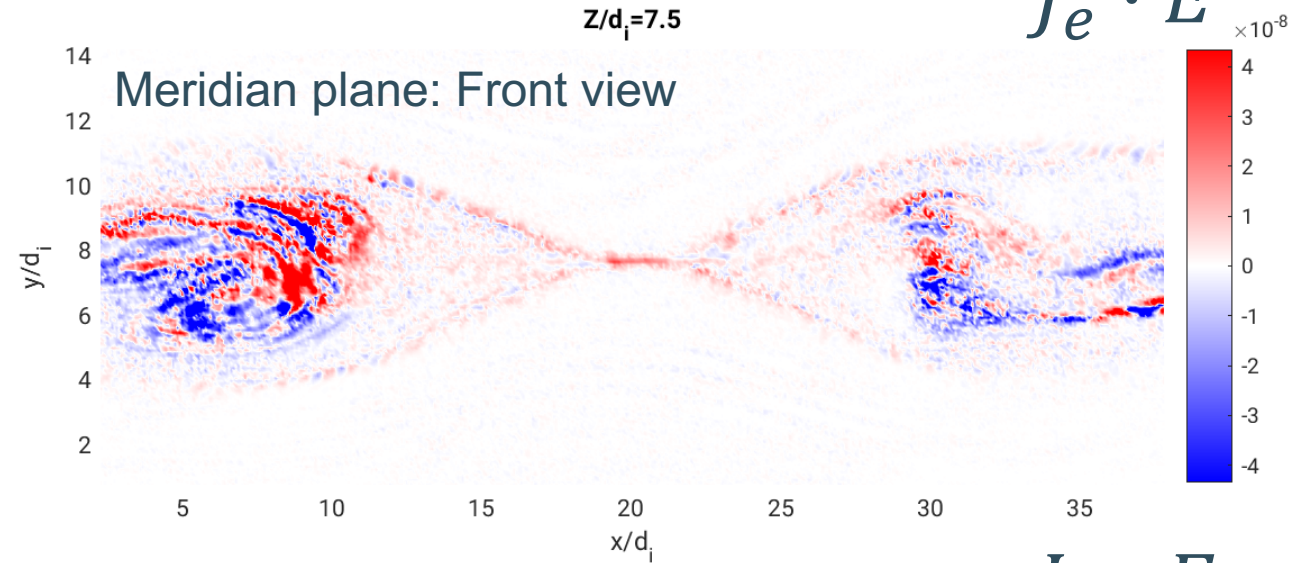
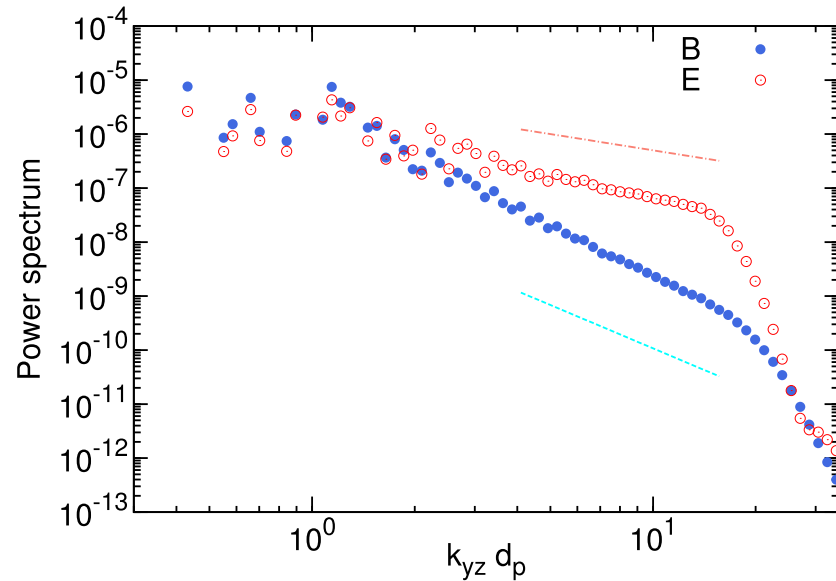
Electron Current Density – Magnitude - Cuts



Electron Current Density – Magnitude –Volume rendering

# The conditions are turbulent and electron scale currents are formed

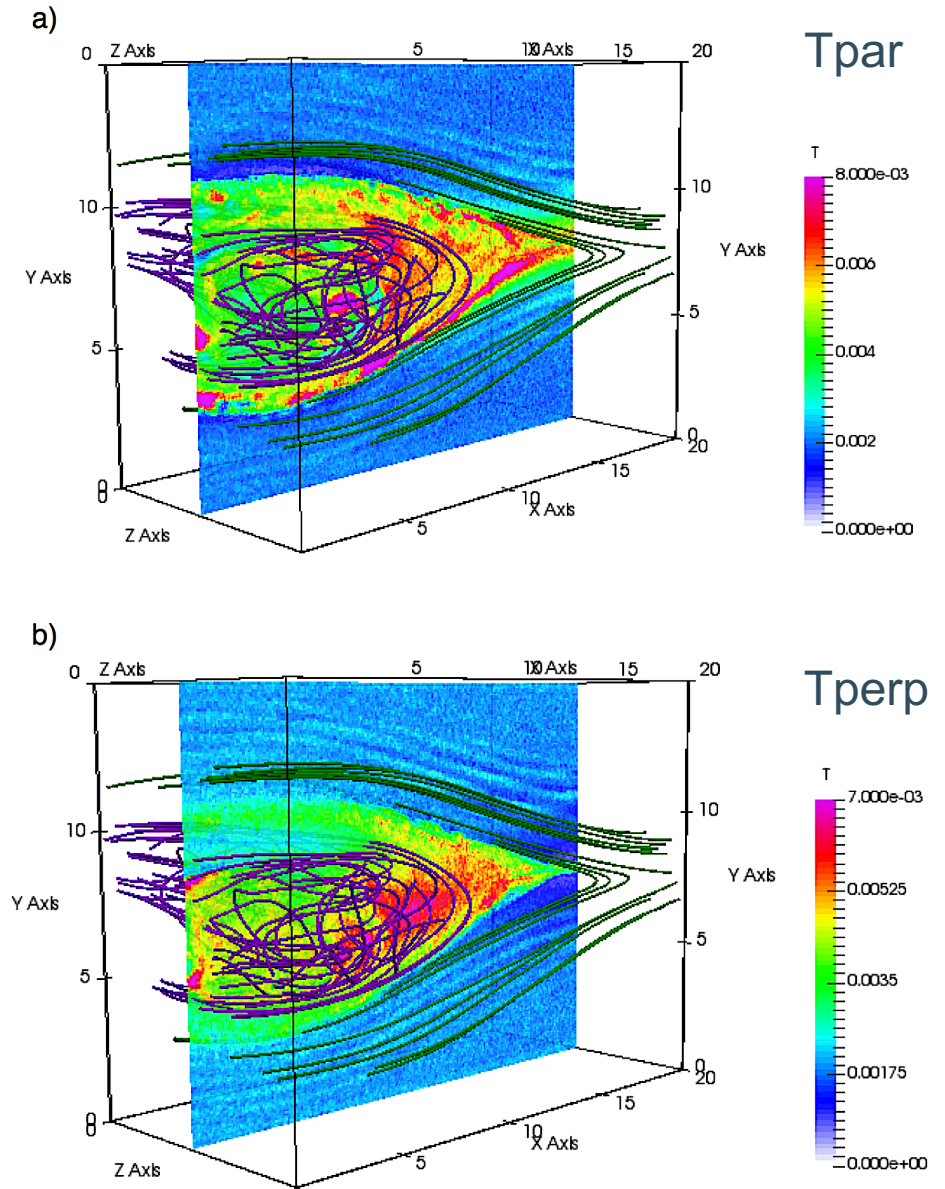
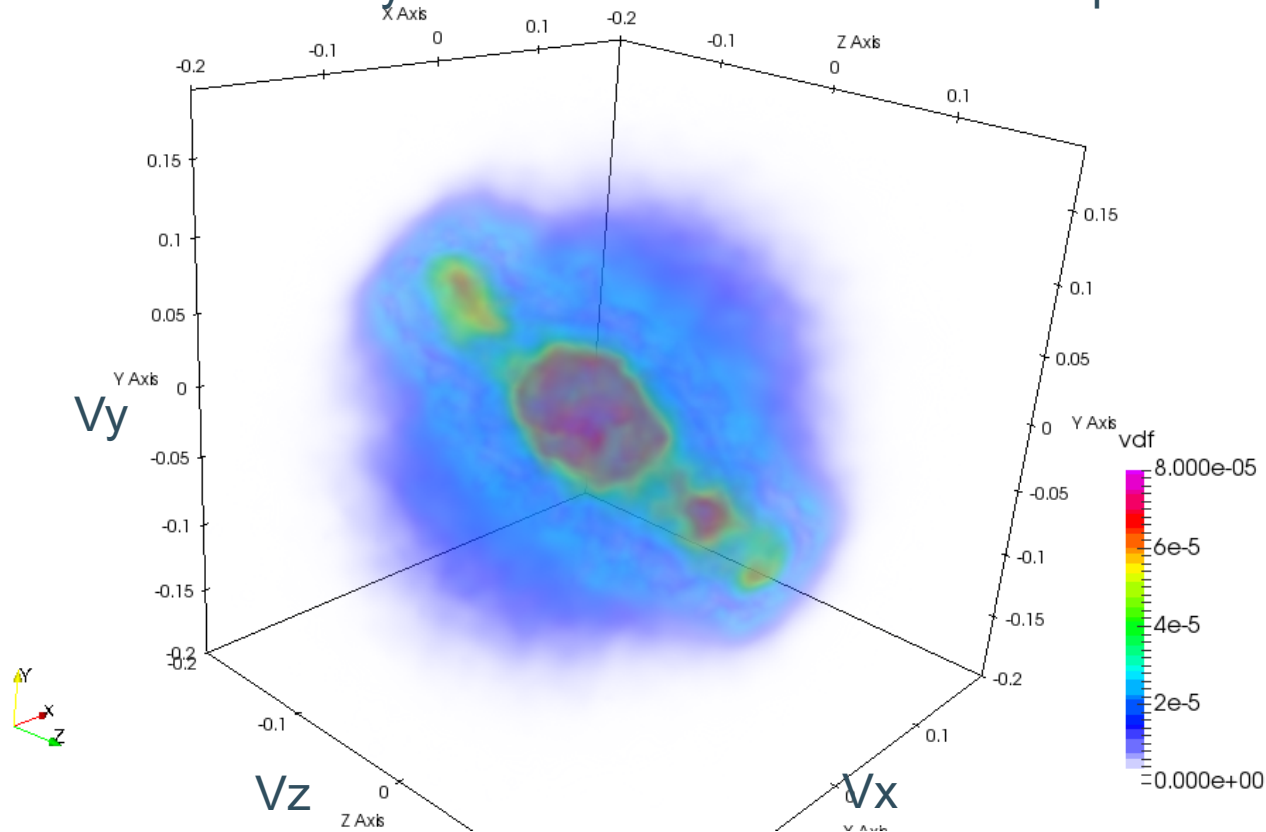
- The reconnection outflows drives the formation of electron currents down to the electron scales (electron gyroradius and electrons skin depth)
- Reconnection there happens via electron processes leaving ions largely unaffected





# Electron energization leads to non Maxwellian distributions

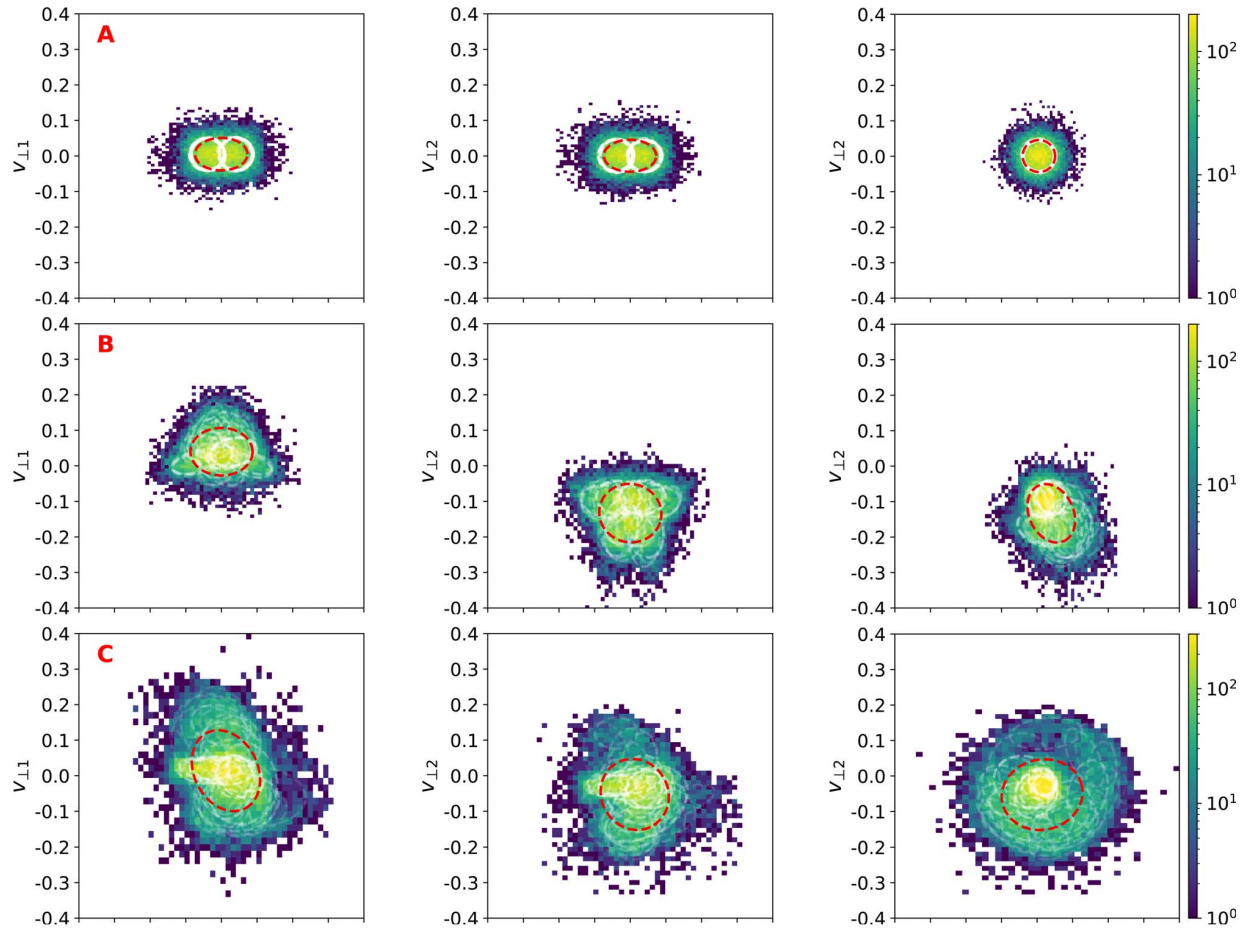
Electron Velocity Distribution: several beams are present





# Gaussian Mixture Model (GMM): Different distributions

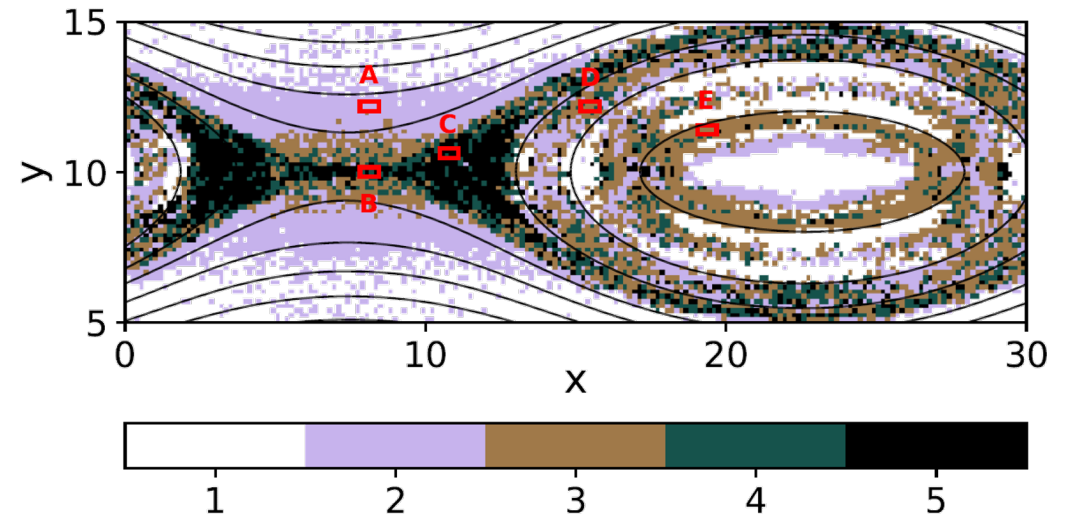
Electron velocity distributions



$$p(\mathbf{x}|\Phi) = \sum_{k=1}^K w_k \mathcal{N}(\mathbf{x}|\theta_k)$$

Determination of the number of Gaussians:

- Akaike information criterion (AIC):  $2k - 2 \ln(L)$
- Bayesian information criterion (BIC):  $\ln(n)k - 2 \ln(L)$ ,  
 $k = \text{number of Gaussians}; L = \text{likelihood}$

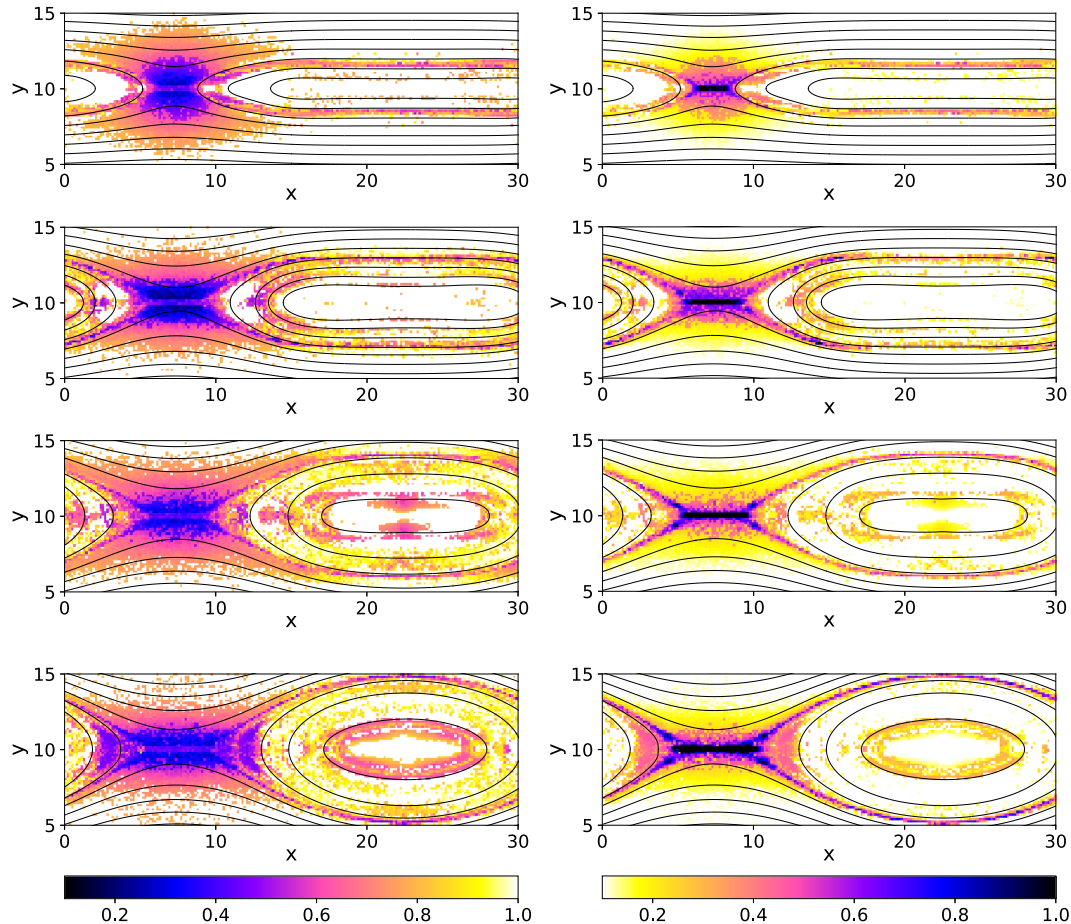


# Effect on the definition of thermal energy

Thermal energy drop    Pseudo (“false”) thermal en.

$$E_{\text{drop}} = \frac{E_{\text{thermal}}^{(K)}}{E_{\text{thermal}}}$$

$$E_{\text{dev}}^{(K)}$$



- Fluid thermal energy:

$$E_{\text{thermal}} = \frac{1}{N_p} \sum_{i=1}^3 \left[ \sum_p (\mathbf{V}_p - \langle \mathbf{V}_p \rangle)^2 \right]_i, \text{ with } \langle \mathbf{V}_p \rangle = \sum_p \frac{\mathbf{V}_p}{N_p}$$

- Multibeam thermal energy

$$E_{\text{thermal}}^{(K)} = \frac{1}{2} \sum_{i=1}^3 \sum_{k=1}^K w_k^2 [\sigma_k^2]_i$$

- Drop in thermal energy

$$E_{\text{drop}} = \frac{E_{\text{thermal}}^{(K)}}{E_{\text{thermal}}}$$

- Pseudo (“false”) thermal energy

$$E_{\text{dev}}^{(K)} = \sum_{i=1}^3 \left[ \sum_{k=1}^K w_k (\mu_k)^2 - \left( \sum_{k=1}^K w_k (\mu_k) \right)^2 \right]_i$$